## TRANSMITTAL

## Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention	COMPRESSIBLE FILMS SURROUNDING SOLDER CONNECTORS
Application Number :	
Date :	
First Named Applica	nt: William E. Bernier
Confirmation Number	er:
Attorney Docket Nu	nber: FIS920040098US1

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Registered Number: 51,564	Reg. No 51564\	

Documents being submitted:	Files
us-request	FIS920040098US1-usrequ.xml
·	us-request.dtd
	us-request.xsl
us-assignment	FIS920040098US1-usassn.xml
	us-assignment.xsl
	us-assignment.dtd
	fis920040098asn1.tif
	fis920040098asn2.tif
	fis920040098asn3.tif
	fis920040098asn4.tif
	fis920040098asn5.tif
	fis920040098asn6.tif
	fis920040098asn7.tif
	fis920040098asn8.tif
us-fee-sheet	FIS920040098US1-usfees.xml
	us-fee-sheet.xsl
	us-fee-sheet.dtd
us-ids	FIS920040098US1-usidst.xml
	us-ids.dtd
	us-ids.xsl
us-declaration	fis920040098dec1.tif
us-declaration	fis920040098dec2.tif
us-declaration	fis920040098dec3.tif
us-declaration	fis920040098dec4.tif
us-declaration	fis920040098dec5.tif
us-declaration	fis920040098dec6.tif
us-declaration	fis920040098dec7.tif
us-declaration	fis920040098dec8.tif
application-body	FIS920040098US1-trans.xml
	us-application-body.xsl
	application-body.dtd
	wipo.ent
	mathml2.dtd
	mathml2-qname-1.mod
	isoamsa.ent
	isoamsb.ent
	isoamsc.ent
	isoamsn.ent
	isoamso.ent
	isoamsr.ent
	isogrk3.ent
	isomfrk.ent
	isomopf.ent
	isomscr.ent
	isotech.ent
	isobox.ent
	isocyr1.ent
	isocyr2.ent
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	isolat1.ent	
	isolat2.ent	
	isonum.ent	
	isopub.ent	
	mmlextra.ent	
	mmlalias.ent	
	soextblx.dtd	
	20040098dwg1.tif	
	20040098dwg2.tif	
	20040098dwg3.tif	
	20040098dwg4.tif	
	20040098dwg5.tif	
	20040098dwg6.tif	
	20040098dwg7.tif	
Comments	20040098dwg7.tif	

## Comments

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